



Customer No.: 31561
Application No.: 10/065,632
Docket NO.: 8012-US-PA

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:)
Application No.: 10/065,632)
Filed: November 5, 2002)
For: Chip Structure With Bumps And A Process)
For Fabricating The Same)

Applicant: Weng, Chao-Fu)
Examiner: Nathan W. Ha)
Art Unit 2814)

No fee is believed to be due. However, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-2620 (Order No.: 8012-US-PA)

AMENDMENT AND RESPONSE TO OFFICE ACTION

U.S. Patent and Trademark Office
Commissioner for Patents
2011 South Clark Place
Customer Window, Mail Stop **Non-Fee Amendment**
Crystal Plaza Two, Lobby, Room 1B03
Arlington, Virginia 22202

Sir:

The Office Action mailed on June 10, 2003 has been carefully considered. In response thereto, please enter the following amendments and consider the following remarks.